



## Thermal expansion behavior, microhardness and electrochemical corrosion resistance properties of $\text{Au}_{52}\text{Cu}_{27}\text{Ag}_{17-x}(\text{NiZn}_{0.5})_x$ alloys

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**Abstract:** The thermal expansion behavior, microhardness and electrochemical corrosion resistance of  $\text{Au}_{52}\text{Cu}_{27}\text{Ag}_{17-x}(\text{NiZn}_{0.5})_x$  ( $x=0, 6$  and  $12$ ) alloys were investigated by dilatometer (DIL), microhardness tester, electrochemical workstation, X-ray diffractometer (XRD), scanning electron microscopy (SEM), transmission electron microscopy (TEM) and X-ray photoelectron spectroscopy (XPS). With increasing  $x$ , the relative length expansion and DIL maximum temperature  $T_{1m}$  (i.e., thermal stability) of the alloys increase in thermal expansion measurements, which can be explained by the change of the atomic binding energy, mismatch entropy together with phase transformation. With the increase of  $x$ , the microhardness can be improved, but the corrosion resistance decreases; in addition, the anodic peak current densities of polarization curves decrease, which are related closely with the solid solution degree and dissolution of Ag, Ni and Zn alloying elements in  $\text{Cl}^-$ -containing solution.

**Key words:** gold alloy; thermal expansion; microhardness; corrosion resistance

### 1 Introduction

Due to good chemical stability, biocompatibility and ductility, the gold is used widely in many fields, such as jewelry industry, dental application and electron component [1–4]. However, the mechanical property of pure gold is relatively poor, which could result in the abrasion and even fracture, hence, alloying is usually used for improving its properties [5,6]. The 18 carat gold composed of 75% Au and 25% master alloys by mass is one of the common gold alloys and is also a popular jewelry gold [7]. The common master alloy elements are Ag, Cu, Ni, Zn, Pd, RE elements, and so on [8,9]. The addition of these alloying elements can improve the processing abilities, mechanical properties and colors of gold alloys.

The essence of thermal expansion is the change of the average lattice spacing with the increase of temperature [10]. Hence, the thermal expansion behavior could reflect the change of lattice structure. In addition, the thermal expansion also is related with some physical

properties of alloys, such as heat capacity, binding energy and melting point [11–13]. Through the thermal expansion behavior, the changes of structure and properties of gold alloys with increasing temperature can be analyzed.

The mechanical property, especially the hardness is the most important characteristic of evaluating the quality of gold alloy. It is known that the hardness is related to other mechanical properties closely [1], the improvement of hardness is helpful for enhancing the abrasion resistance and strength of alloy. Although there are some studies on the strengthening mechanism of alloying elements for the hardness of gold alloys, such as solid solution strengthening, precipitation strengthening, grain refinement strengthening, work hardening and aging strengthening [14,15], but the effect of master alloys which contain several alloying elements is still worthy of being explored.

Because of the direct contact with human skins, the corrosion resistance of the 18 carat gold alloy in the sweat environment is necessary to be investigated. The reaction between the gold alloys with sweat could result

in the discoloration of the alloy [16]. In addition, the release of alloying elements, especially the Ni release could lead to the allergy of skin [17–19]. These are the main disadvantages which hinder the application of gold alloys as the jewelry. Therefore, studying the electrochemical corrosion behavior of 18 carat gold alloys is indispensable for improving the corrosion resistance.

In this study, we chose three 18 carat gold alloys with different master alloy compositions, i.e., the  $\text{Au}_{52}\text{Cu}_{27}\text{Ag}_{17-x}(\text{NiZn}_{0.5})_x$  ( $x=0, 6$  and  $12$ ) alloys with the change of the Ag, Ni and Zn elements contents. The thermal expansion behavior, microhardness and electrochemical corrosion resistance properties were investigated, in order to analyze the effect of master alloys on the properties of 18 carat gold alloys.

## 2 Experimental

The  $\text{Au}_{52}\text{Cu}_{27}\text{Ag}_{17-x}(\text{NiZn}_{0.5})_x$  ( $x=0, 6$  and  $12$ ) alloys were employed in this study. The pure Au (99.99%) and master alloys (CuAg and CuZnNi) were smelted in crucible by oxygen and acetylene spray gun and then the uniform molten liquid were poured into cast iron mold, after being cooled in the air, the ingots were pressed into thin slices. The compositions of alloys are shown in Table 1.

**Table 1** Compositions of  $\text{Au}_{52}\text{Cu}_{27}\text{Ag}_{17-x}(\text{NiZn}_{0.5})_x$  ( $x=0, 6$  and  $12$ ) alloys (mole fraction, %)

$x$	Au	Cu	Ag	Ni	Zn
0	54.96	28.29	16.75	0	0
6	52.73	27.43	10.82	5.99	3.03
12	50.63	26.97	5.24	11.73	5.43

The samples were investigated by X-ray diffractometer (XRD) with a Cu target (Cu  $K_{\alpha}$ ,  $\lambda=0.154056$  nm). In order to calculate the lattice constant  $a_0$  of phases in alloys, the extended Bragg equation [20] was used as follows:

$$a_0 = \frac{\lambda}{2 \sin \theta} \sqrt{h^2 + k^2 + l^2} \quad (1)$$

where  $\lambda$  is the radiation wavelength,  $\theta$  is the diffraction angle, and  $h$ ,  $k$  and  $l$  are the crystal plane indices.

The morphologies of samples were observed by field emission scanning electron microscopy (SEM, SU-70). The compositions of corresponding regions were analyzed by energy dispersive spectrometer (EDS). Transmission electron microscopy (TEM, JEM-2100) was used to further observe the structure of samples. The TEM specimens were prepared by mechanical thinning to 60  $\mu\text{m}$  and then ion milling. The surface layer elements of samples after electrochemical polarization

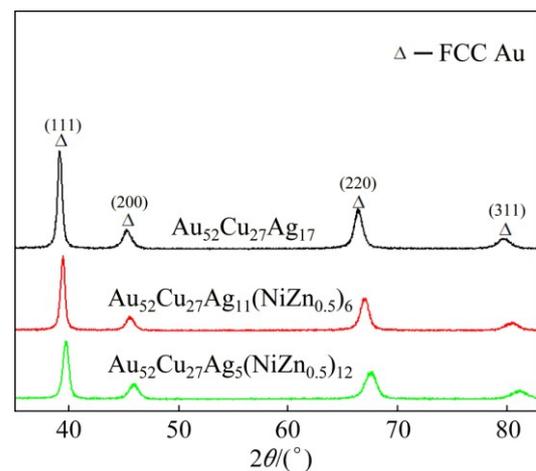
test were investigated by X-ray photoelectron spectroscopy (XPS, Escalab 250) with monochromatized Al  $K_{\alpha}$  excitation.

The microhardness of each sample was measured for 9 times with 0.05 kg load and 30 s holding time using DHV-1000 digital micro-hardness tester. Thermal expansion curves were measured by a dilatometer (DIL, Netzsch 402C) with a constant heating rate 10 K/min. The lengths of the tested samples were 12.65, 13.58 and 13.36 mm, respectively. The potentiodynamic polarization tests with a scanning rate of 5 mV/s at room temperature were carried out by CHI660E advanced electrochemical workstation with a typical three-electrode system in electrochemical measurements: working electrode, platinum counter electrode and Hg|Hg<sub>2</sub>Cl<sub>2</sub> (SCE) reference electrode. The electrolyte is artificial sweat solution (0.5% NaCl, 0.1% lactic acid and 0.1% urea, adjusted to pH 6.5 with weak aqua ammonia). The artificial sweat was prepared according to GB/T 19719—2005 standard of China, and was used at the temperature of 37 °C.

## 3 Results

### 3.1 XRD and TEM results

Figure 1 shows the XRD patterns of samples, as well as the diffraction angles and lattice constants  $a_0$  of (200) peaks. Here,  $a_0$  is calculated by Eq. (1). It can be seen that all samples exhibit similar diffraction peaks which can be nearly assigned to face-center cubic (FCC)



Alloy	$2\theta/(\circ)$	$a_0/\text{nm}$
Pure Au	44.392	0.4079
$\text{Au}_{52}\text{Cu}_{27}\text{Ag}_{17}$	45.281	0.4002
$\text{Au}_{52}\text{Cu}_{27}\text{Ag}_{11}(\text{NiZn}_{0.5})_6$	45.601	0.3975
$\text{Au}_{52}\text{Cu}_{27}\text{Ag}_5(\text{NiZn}_{0.5})_{12}$	46.040	0.3940

**Fig. 1** XRD patterns of  $\text{Au}_{52}\text{Cu}_{27}\text{Ag}_{17-x}(\text{NiZn}_{0.5})_x$  ( $x=0, 6$  and  $12$ ) alloys, as well as diffraction angles and lattice constants of (200) peaks

crystalline Au structure, and the positions of peaks ( $2\theta$ ) all shift slightly towards the higher diffraction angles with increasing  $x$ . According to Eq. (1), a higher diffraction angle represents a lower lattice constant, i.e., the lattice contracts with the increase of  $x$ . It is known that Cu, Ag and Ni could form continuous solid solution with Au [21,22], Zn can be soluble in Cu and Ni solid solutions. In addition, there are no apparent peaks of intermetallic compounds detected in XRD patterns due to their low contents. Therefore, it can be thought that the alloys are mainly constituted by the Au solid solution. The atom radius of Ag is similar to that of Au, so the lattice distortion caused by Ag is not obvious. The higher shifts of peak positions can be ascribed to the obvious smaller atom radius of Cu, Ni and Zn atoms which could replace some Au atoms in structure and shorten the distance between atoms [23–25].

The TEM images and corresponding selected area electron diffraction patterns (SAED) of  $\text{Au}_{52}\text{Cu}_{27}\text{Ag}_{17}$  and  $\text{Au}_{52}\text{Cu}_{27}\text{Ag}_5(\text{NiZn}_{0.5})_{12}$  alloys are shown in Fig. 2. The bright field images show that the  $\text{Au}_{52}\text{Cu}_{27}\text{Ag}_5(\text{NiZn}_{0.5})_{12}$  alloy is more easily thinned, and there are some particles on the surface of both alloys. Based on the identified lattice, it can be found that the compositions of both alloys are mainly Au phase, while in  $\text{Au}_{52}\text{Cu}_{27}\text{Ag}_5(\text{NiZn}_{0.5})_{12}$  alloy, some intermetallic compounds are demarcated more easily. The SAED patterns further verify the coexistence of Au solid solution and some intermetallic compounds in alloys, which is consistent with XRD results (Figs. 1 and 2).

### 3.2 Thermal expansion and microhardness

Figure 3 exhibits the thermal expansion (DIL) curves and corresponding coefficients of thermal expansion (CTE) curves of three samples.  $T_{\text{lm}}$  and  $T_{\text{cm}}$  respectively represent the DIL maximum temperature and CTE maximum temperature, and the  $T_{\text{lm}}$  points can also be thought as the inflection points of the thermal expansion curves. All the thermal expansion curves rise with increasing temperature and the relative length expansions ( $\Delta L/L_0$ ) increase with increasing  $x$ , which can be thought as the linear thermal expansion stages before the inflection points. While after the respective inflection point, the thermal expansion curves all have a decline trend. It also can be found that the  $T_{\text{lm}}$  and  $T_{\text{cm}}$  both increase with increasing  $x$ . Since, the increase of  $x$  reflects the enhancement of solid solubility, there should be some links between the thermal expansion behavior and the solid solubility (Figs. 1 and 3).

The coefficient of thermal expansion ( $\alpha$ ) which is defined as fractional change in length per unit change in temperature can be expressed by the following equation [26,27]:

$$\alpha = \frac{\Delta L}{L_0 \times \Delta T} \quad (2)$$

where  $L_0$  is the length of tested sample,  $\Delta L$  is the thermal expansion increment of sample when temperature variation value is  $\Delta T$ . The average coefficient of thermal expansion ( $\bar{\alpha}$ ) is shown in Fig. 4(a), it is obvious that the  $\bar{\alpha}$  increases with increasing  $x$ . With regard to the

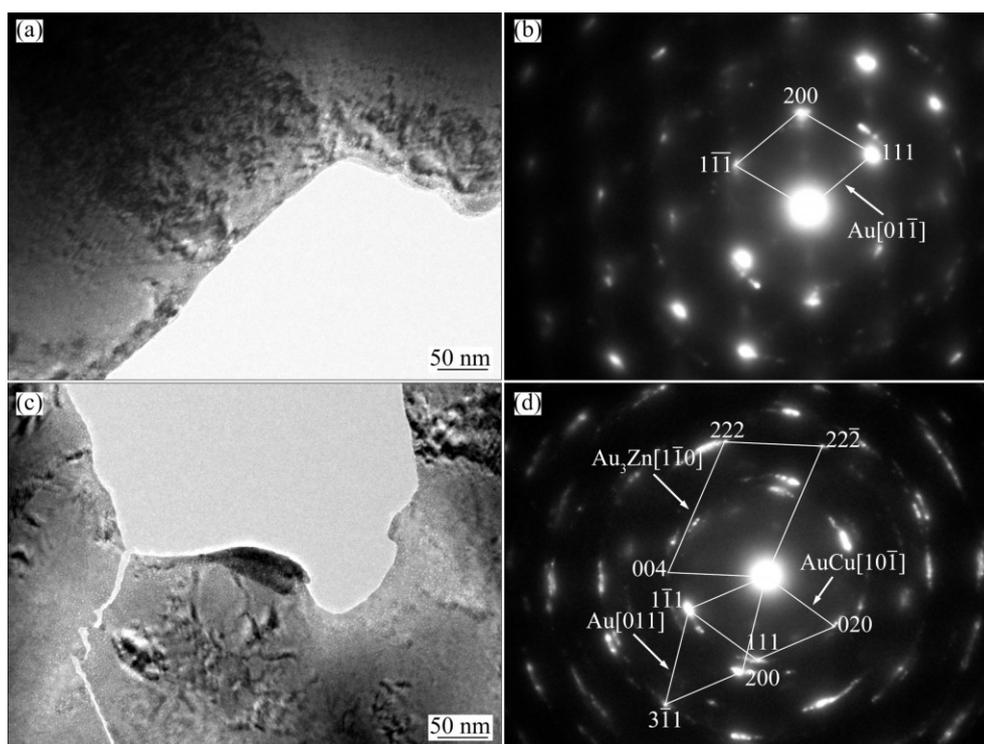
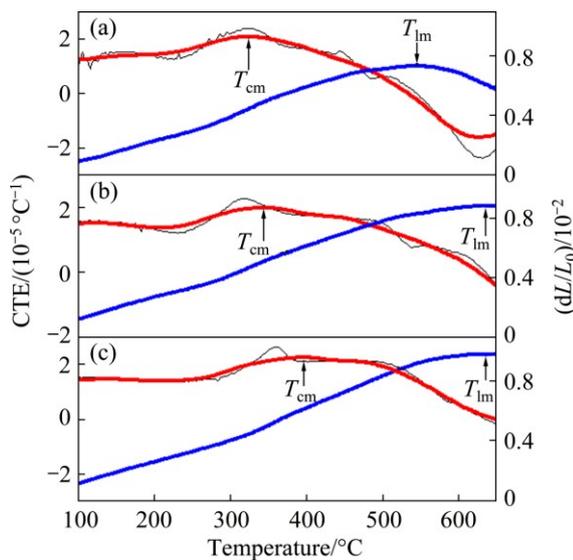
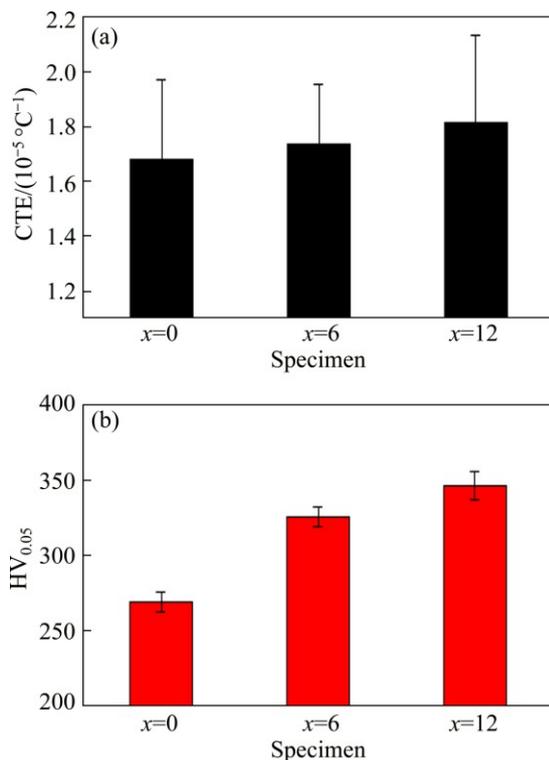


Fig. 2 TEM images and corresponding SAED patterns of  $\text{Au}_{52}\text{Cu}_{27}\text{Ag}_{17-x}(\text{NiZn}_{0.5})_x$  alloys: (a, b)  $x=0$ ; (c, d)  $x=12$



**Fig. 3** Thermal expansion curves (blue line) and experimental coefficients of thermal expansion (CTE) curves (red line) of  $\text{Au}_{52}\text{Cu}_{27}\text{Ag}_{17-x}(\text{NiZn}_{0.5})_x$  ( $x=0, 6$  and  $12$ ) alloys



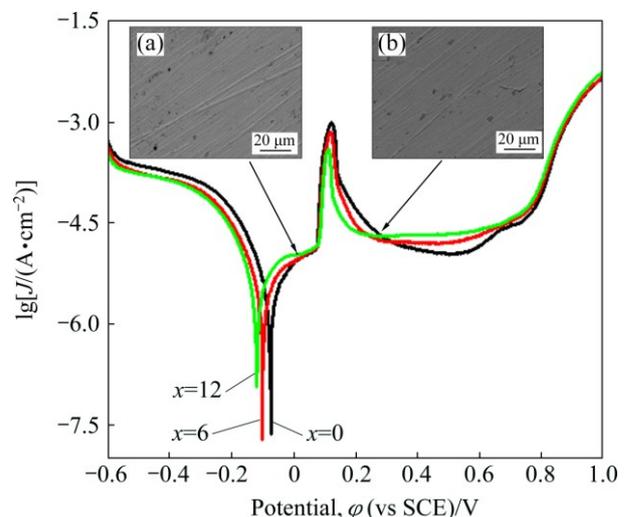
**Fig. 4** Average coefficient of thermal expansion ( $\bar{\alpha}$ ) of range of  $100 \text{ } ^\circ\text{C}$  to  $T_{\text{cm}}$  (a) and microhardness of  $\text{Au}_{52}\text{Cu}_{27}\text{Ag}_{17-x}(\text{NiZn}_{0.5})_x$  ( $x=0, 6$  and  $12$ ) alloys (b)

CTE curve which is usually used for expressing the effect of thermal expansion phenomenon on alloy [28], it can be seen that in the early stage, the curves of all samples keep nearly steady, and then after rise to their maximums at  $T_{\text{cm}}$  points, they begin to decline with increasing temperature.

The microhardness histograms of samples are shown in Fig. 4(b). It can be seen apparently that the  $\text{Au}_{52}\text{Cu}_{27}\text{Ag}_{17}$  alloy exhibits the lowest microhardness, while  $\text{Au}_{52}\text{Cu}_{27}\text{Ag}_5(\text{NiZn}_{0.5})_{12}$  alloy exhibits the largest one, i.e., the microhardness values of samples increase with increasing  $x$ .

### 3.3 Potentiodynamic polarization

Figure 5 shows the potentiodynamic polarization curves tested in the artificial sweat solution. All the polarization curves exhibit the similar shapes, suggesting the same electrochemical corrosion behaviors. It can be seen that the corrosion potential ( $\phi_{\text{corr}}$ ) of the  $\text{Au}_{52}\text{Cu}_{27}\text{Ag}_{17}$  alloy is the highest among three samples, and that of the  $\text{Au}_{52}\text{Cu}_{27}\text{Ag}_5(\text{NiZn}_{0.5})_{12}$  alloy is the lowest. On the contrary, the corrosion current density ( $J_{\text{corr}}$ ) of the  $\text{Au}_{52}\text{Cu}_{27}\text{Ag}_{17}$  alloy is the lowest, while that of the  $\text{Au}_{52}\text{Cu}_{27}\text{Ag}_5(\text{NiZn}_{0.5})_{12}$  alloy is the highest. Therefore, it can be thought that the corrosion resistance abilities of the alloys get worse with increasing  $x$ . It also can be noticed that the width of passivation ranges of alloys are nearly equal, while the passivation current densities increase with increasing  $x$ , which implies that higher  $x$  of the alloys results in worse stabilities of passive films. Therefore, the passivation current densities also indicate a worse corrosion resistance ability of the alloy which has a higher  $x$ .



**Fig. 5** Potentiodynamic polarization curves of  $\text{Au}_{52}\text{Cu}_{27}\text{Ag}_{17-x}(\text{NiZn}_{0.5})_x$  ( $x=0, 6$  and  $12$ ) alloys in artificial sweat solution (The insets are the SEM images of the alloys before (a) and after (b) the anodic current peaks)

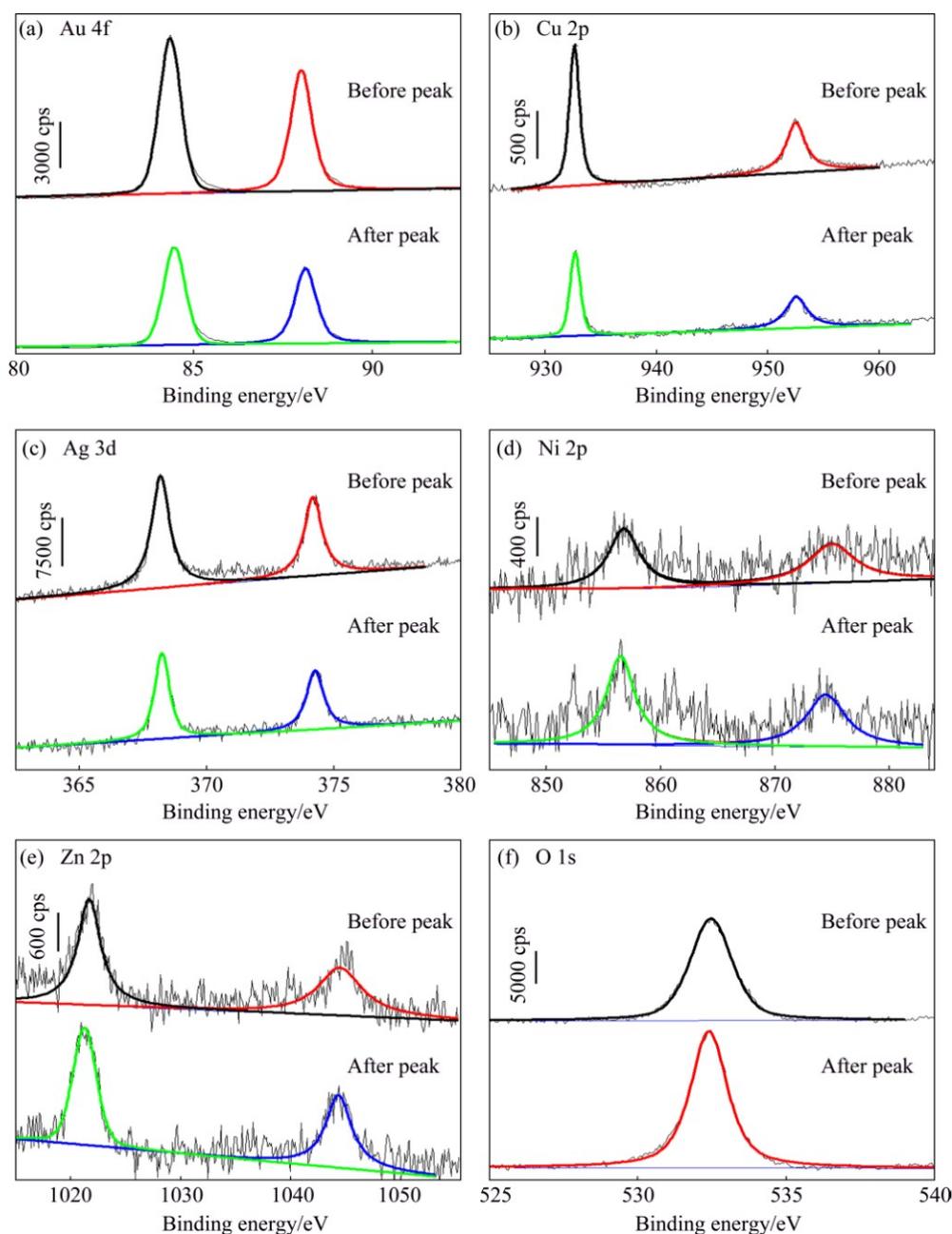
Moreover, the peaks of all polarization curves appear which can be defined as anodic current peaks before the broad passivation ranges. The corresponding potentials and current densities of the peaks are listed in Table 2. It can be found that with increasing  $x$ , the peak potentials and current densities decrease. In addition, the

insets of Fig. 5 are the SEM images of samples of which the polarization measurement was stopped before and after the appearance of the peaks, respectively. However, the surface morphologies are not obviously different between the samples obtained before and after the peaks.

**Table 2** Potentials and current densities of anodic current peaks deduced from potentiodynamic polarization curves

Alloy	Potential/V	Current density/ ( $10^{-4}\text{A}\cdot\text{cm}^{-2}$ )
$\text{Au}_{52}\text{Cu}_{27}\text{Ag}_{17}$	0.122	9.687
$\text{Au}_{52}\text{Cu}_{27}\text{Ag}_{11}(\text{NiZn}_{0.5})_6$	0.119	6.988
$\text{Au}_{52}\text{Cu}_{27}\text{Ag}_5(\text{NiZn}_{0.5})_{12}$	0.112	3.948

Figure 6 exhibits the XPS spectra which could reflect the variation of elements of the  $\text{Au}_{52}\text{Cu}_{27}\text{Ag}_5(\text{NiZn}_{0.5})_{12}$  alloy surfaces before and after the peaks, while the corresponding binding energies ( $E_B$ ) are listed in Table 3. It can be seen that compared to the samples before the peaks, there are some changes of the XPS spectra of the samples after the peaks. According to the XPS spectra and  $E_B$  (Fig. 6 and Table 3), the electronic structure of Au 4f before and after current peak can both be thought as the coexistence of  $\text{Au}^0$  and  $\text{Au}^+$  [29] (Fig. 6(a)). The  $E_B$  of Cu 2p is corresponding to the  $\text{Cu}^+$  [30] (Fig. 6(b)), and the  $E_B$  of Ag 3d characterizes the coexistence of  $\text{Ag}^0$  and  $\text{Ag}^+$  [4,31] (Fig. 6(c)). Accordingly, the  $E_B$  of Ni 2p represents the



**Fig. 6** XPS spectra of  $\text{Au}_{52}\text{Cu}_{27}\text{Ag}_5(\text{NiZn}_{0.5})_{12}$  alloys before and after anodic current peaks of polarization curves tested in artificial sweat solution

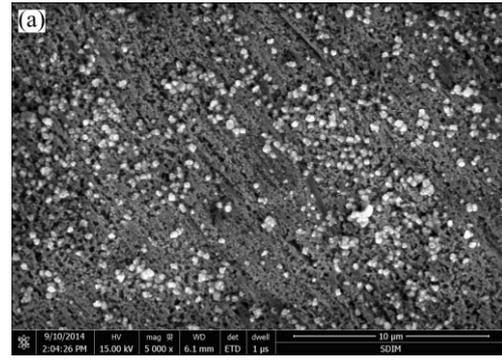
**Table 3** Binding energies ( $E_B$ ) of elements before anodic peak ( $E_{B1}$ ) and after anodic peak ( $E_{B2}$ ) deduced from XPS spectrum

Element	$E_{B1}/\text{eV}$	$E_{B2}/\text{eV}$	$\Delta E_B/\text{eV}$
Au 4f	84.34	84.46	0.12
	88.02	88.14	0.12
Cu 2p	932.67	932.73	0.06
	952.52	952.59	0.07
Ag 3d	368.20	368.26	0.06
	374.19	374.27	0.08
Ni 2p	856.81	856.51	-0.30
	875.97	874.48	-1.49
Zn 2p	1021.71	1021.29	-0.42
	1044.51	1044.37	-0.14
O 1s	532.47	532.40	-0.07

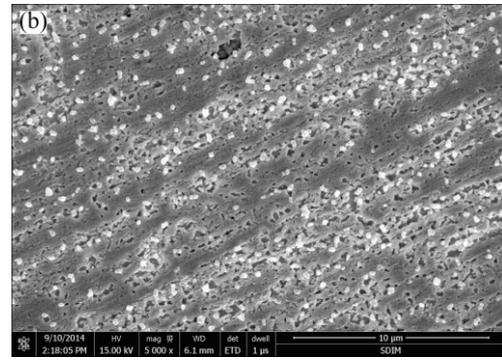
$$\Delta E_B = E_{B_2} - E_{B_1}$$

existence of  $\text{Ni}^{2+}$  and  $\text{Ni}^{3+}$  [32], and that of Zn 2p represents the  $\text{Zn}^{2+}$  [33] (Figs. 6(d) and (e)). The  $\Delta E_B$  shows that compared with the samples before anodic current peak, the  $E_B$  of Au, Cu and Ag of samples after the peaks shift towards the higher values and those of Ni, Zn and O of samples after the peaks become lower (Table 3).

Figure 7 shows the SEM morphologies of the alloys after being tested in artificial sweat solution by polarization curve measurements. It can be found that the pits of the  $\text{Au}_{52}\text{Cu}_{27}\text{Ag}_5(\text{NiZn}_{0.5})_{12}$  alloy are more than that of the  $\text{Au}_{52}\text{Cu}_{27}\text{Ag}_{17}$  alloy, which can also prove that the higher  $x$  results in worse corrosion resistance. Some white particles disperse on both sample surfaces. According to the corresponding EDS results, the contents of Au, Cu, Ni and Zn in the matrix are higher than those in the particle, while the Ag content in the particle is much higher than that in the matrix and the Cl elements can be found only in the particles. Hence, the particles may be constituted mainly by AgCl due to the measurement in the  $\text{Cl}^-$ -containing solution. In addition, Fig. 8 shows the SEM morphologies of  $\text{Au}_{52}\text{Cu}_{27}\text{Ag}_{17}$  and  $\text{Au}_{52}\text{Cu}_{27}\text{Ag}_5(\text{NiZn}_{0.5})_{12}$  alloys which were eroded by the mixture solution of HCl and  $\text{HNO}_3$  ( $V_{\text{HCl}} : V_{\text{HNO}_3} = 1:1$ ). It is apparent that the pits of  $\text{Au}_{52}\text{Cu}_{27}\text{Ag}_5(\text{NiZn}_{0.5})_{12}$  alloy are much larger than that of  $\text{Au}_{52}\text{Cu}_{27}\text{Ag}_{17}$  alloy, which is in accordance with the above results that the corrosion resistance of the alloy decreases with increasing  $x$ . However, there are some particles dispersed on the samples, and the particles of  $\text{Au}_{52}\text{Cu}_{27}\text{Ag}_{17}$  alloy are much more than that of  $\text{Au}_{52}\text{Cu}_{27}\text{Ag}_5(\text{NiZn}_{0.5})_{12}$  alloy. According to the EDS results, the Au and Cu contents of the matrix are higher than those of particles, while the contents of Ag, Ni and Zn of the matrix are lower than those of particles. Especially, the Ag content of particles is apparently higher than that of the matrix, and the Ag contents as well as the particles both decrease with



	Mole fraction/%			
	Au	Cu	Ag	Cl
Matrix	56.8	29.8	13.4	
Particle	41.4	20.0	26.1	12.4



	Mole fraction/%					
	Au	Cu	Ag	Ni	Zn	Cl
Matrix	53.7	25.2	3.5	12.2	5.4	
Particle	40.9	14.6	23.6	6.4	4.7	9.8

**Fig. 7** SEM images and EDS results of  $\text{Au}_{52}\text{Cu}_{27}\text{Ag}_{17-x}(\text{NiZn}_{0.5})_x$  ((a)  $x=0$ , (b)  $x=12$ ) alloys after full polarization in artificial sweat solution

increasing  $x$ , hence, it can be thought that these particles may be the corrosion products which are mainly composed of Ag element.

## 4 Discussion

### 4.1 Thermal expansion behavior of $\text{Au}_{52}\text{Cu}_{27}\text{Ag}_{17-x}(\text{NiZn}_{0.5})_x$ ( $x=0, 6$ and $12$ ) alloys

It is known that mixing enthalpy is related with the expansion of the solid solutions [34,35]. Table 4 shows the mixing enthalpy ( $\Delta H_{\text{mix}}$ ), the mismatch entropy normalized by the Boltzmann constant ( $S_\sigma/k_B$ ) and the relative length expansion ( $\Delta L/L_0$ ). The  $\Delta H_{\text{mix}}$  and  $S_\sigma/k_B$  were calculated by the following equations [36]:

$$\Delta H^{\text{chem}} = \sum_{\substack{i=1 \\ i \neq j}} \Omega_{ij} c_i c_j \quad (3)$$

$$\frac{S_\sigma}{k_B} = \frac{3}{2}(\zeta^2 - 1)y_1 + \frac{3}{2}(\zeta - 1)^2 y_2 -$$

$$\left[ \frac{1}{2}(\zeta - 1)(\zeta - 3) + \ln \zeta \right] (1 - y_3) \quad (4)$$

$$y_1 = \frac{1}{\sigma_3} \sum_{j>i=1} (d_i + d_j)(d_i - d_j)^2 c_i c_j \quad (5)$$

$$y_2 = \frac{\sigma^2}{(\sigma_3)^2} \sum_{j>i=1} d_i d_j (d_i - d_j)^2 c_i c_j \quad (6)$$

$$y_3 = \frac{(\sigma^2)^3}{(\sigma^3)^2} \quad (7)$$

$$\sigma^k = \sum_{i=1} c_i d_i^k; k = 2, 3 \quad (8)$$

where  $\Omega_{ij}$  is the regular solution interaction parameter between the  $i$  and  $j$  elements, and  $c_i$  is the atomic mole fraction of the  $i$  element.  $\zeta$  is defined as  $\zeta=1/(1-\xi)$  with a packing fraction  $\xi$  which is fixed to be 0.64.  $y_1$ ,  $y_2$  and  $y_3$  are dimensionless parameters and they have a relation:  $y_1+y_2+y_3=1$ .  $d_i$  is the atomic diameter. It can be seen that the lower the master alloy content  $x$ , the more negative the  $\Delta H_{\text{mix}}$  as well as the lower  $\Delta L/L_0$  (Table 4). However, the  $\Delta H_{\text{mix}}$  could reflect the binding energies [37], hence, a lower  $x$  value represents a higher binding energy which implies the lower  $\Delta L/L_0$ . As mentioned above, it can be thought that the substitution of Ni and Zn atoms with Au atoms results in the weakening of the binding energy in the FCC solid solution matrix [38]. Therefore, the higher the  $x$  value, the higher the  $\Delta L/L_0$  during the heating processes (Fig. 3 and Table 4).

**Table 4** Mixing enthalpy ( $\Delta H_{\text{mix}}$ ), mismatch entropy normalized by Boltzmann constant ( $S_\sigma/k_B$ ) and relative length expansion ( $\Delta L/L_0$ ) of alloy during thermal expansion measurement

Alloy	$\Delta H_{\text{mix}}/(\text{kJ}\cdot\text{mol}^{-1})$	$S_\sigma/k_B$	$\Delta L/L_0$
Au <sub>52</sub> Cu <sub>27</sub> Ag <sub>17</sub>	-7.40	0.061	0.731
Au <sub>52</sub> Cu <sub>27</sub> Ag <sub>11</sub> (NiZn <sub>0.5</sub> ) <sub>6</sub>	-5.87	0.069	0.880
Au <sub>52</sub> Cu <sub>27</sub> Ag <sub>5</sub> (NiZn <sub>0.5</sub> ) <sub>12</sub>	-4.70	0.078	0.980

The change of CTE may reflect the variation of structure during the heating process like the phase transformation  $\alpha \rightarrow \gamma$  in Fe-C alloys [39,40]. Generally, the increase of the temperature can influence the solubility of the matrix phase and result in the phase transformations [41,42]. Analogously, the contraction of the alloy in this study may be related with the solid solubility changes and phase transformations during heating process. In fact, for Au-Cu-Ag system, with the increase of the temperature, the solid solubility would increase [43,44]. Hence, the more Ni and Zn atoms will substitute Au atoms, which could result in the shrinkage of lattice (Fig. 1). In addition, the AuCu phases which

have been detected by SAED measurement in tested alloys (Fig. 2) can generate order-disorder transition with increasing temperature, i.e., the order AuCu phase could change into a disorder structure [40,45,46]. As mentioned above, the contraction of the alloy during heating process can be ascribed to the changes of solid solubility and phase transformation.

In addition, the  $S_\sigma/k_B$  increases with increasing  $x$  (Table 4), and a higher mismatch entropy could represent a more difficulty of phase transformation. Hence, with increasing  $x$ , the increase trend of DIL maximum temperature  $T_{\text{lm}}$ , corresponding to the increase of phase transformation temperature which means the improvement of thermal stability of the alloy, can be ascribed to the variation of the mismatch entropy.

## 4.2 Microhardness and solid solubility of Au<sub>52</sub>Cu<sub>27</sub>Ag<sub>17-x</sub>(NiZn<sub>0.5</sub>)<sub>x</sub> alloys

It is known that the solid solution strengthening stems from the restriction of dislocation movement caused by the interaction of dislocation with the distorted lattice surrounding the solute atoms [47]. Commonly, with the increase of the amount of solute atoms in solid solution, the improvement of the strength of alloy is expected [48]. The variation of  $x$  represents the decrease of Ag content and the increase of Ni and Zn contents in structure of the alloy (Table 1). However, Ni can enhance the mechanical performance of the alloy [17,49]. The following equation is often used for the estimate of the solid solution strengthening effects of alloy elements on the Au-based alloy [15]:

$$H_s = A \cdot B \quad (9)$$

where  $A$  and  $B$  represent the atomic mass ratio and the atomic radius difference between Au and alloying atom, respectively. A higher  $H_s$  indicates a larger lattice distortion which could result in a better solid solution effect. Being calculated by Eq. (9), the  $H_s$  of Ag, Ni and Zn are 0.004, 0.443 and 0.230, respectively. It is apparent that the Ni and Zn atoms have much higher  $H_s$  than Ag atom. In fact, due to the similar atomic mass and radius to that of Au, the Ag atom has weak solid solution strengthening effect. According to XRD results, the main compositions of all alloys are FCC solid solutions. With increasing the  $x$ , a higher shift of peak position, i.e., a larger deviation with the pure Au diffraction peak, indicates a higher solid solubility (Fig. 1). Hence, the solid solution strengthening can be considered as the main strengthening mechanism in this study. The increase of Ni and Zn can improve the hardness of the alloy, while the decrease of Ag content has a weak effect on the solid solution strengthening for Au (Fig. 4(b)).

### 4.3 Electrochemical polarization behavior of $\text{Au}_{52}\text{Cu}_{27}\text{Ag}_{17-x}(\text{NiZn}_{0.5})_x$ ( $x=0, 6$ and $12$ ) alloys

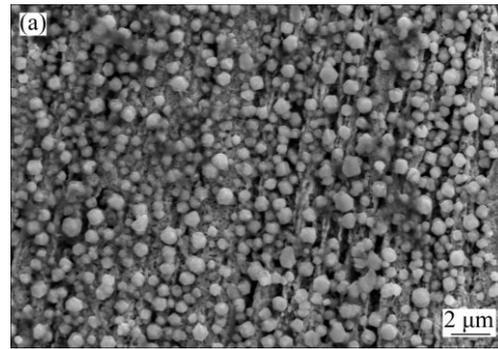
It can be seen from the Au–Ni binary alloy phase diagram that, the solid state separation into Au-rich and Ni-rich phases occurs below 821 °C [50]. The same phase decomposition also occurs in Au–Cu–Ni ternary alloy and Au–Cu–Ni–Zn alloy in the similar manner [51]. Hence, the higher  $x$  may imply the higher content of Ni-rich phases in the tested alloy. It is known that the standard electrode potential  $\varphi^0$  (vs SHE) of electrochemical reaction  $\text{Au}=\text{Au}^{3+}+3\text{e}$  is 1.50 V (SHE represents the reference electrode of standard hydrogen electrode), while that of electrochemical reaction  $\text{Ni}=\text{Ni}^{2+}+2\text{e}$  is  $-0.250$  V [52]. Therefore, it is expected that the corrosion potentials  $\varphi_{\text{corr}}$  and corrosion resistance decrease with increasing  $x$  (Fig. 5), which is similar to the results in Ref. [17].

According to the Refs. [53,54], the formation of the anodic current peak can be ascribed to the oxidation of alloying elements, i.e., the active dissolution process. Usually, for most transition metals, a higher  $E_B$  represents a higher oxidation state, while Ag is one of the few metals which exhibit the lower  $E_B$  in the oxidation state [55]. Hence, it is indicated that the degrees of oxidation of Au and Cu of samples after current peaks are higher than that of samples before current peaks, while the degrees of oxidation of Ag, Ni and Zn have the opposite change tendency (Fig. 6 and Table 3). Meanwhile, the electrode potentials of Ag, Ni and Zn are lower than that of Au, but the degrees of oxidation of Ag, Ni and Zn shift towards the lower values rather than the higher values after the peaks. Since the dissolution can result in the decrease of the oxide on the sample surfaces, i.e., the oxide degree decreases, therefore, the dissolution of Ag, Ni and Zn can be thought as the main reason why the oxidation degrees of these elements of the samples surfaces decline. As mentioned above, the anodic current peaks of polarization curves of the alloys can be ascribed to the oxidation of the surface elements, especially the dissolution of the Ag, Ni and Zn.

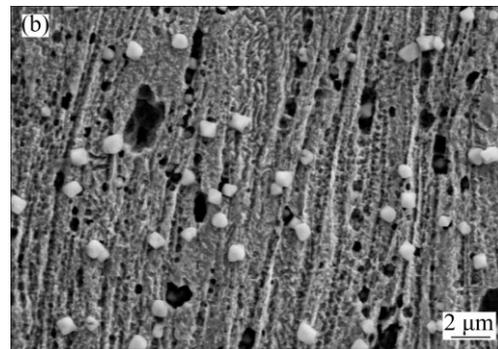
Since the Ag content in the corrosion products is higher than those of Ni and Zn (Fig. 8). In the solution containing  $\text{Cl}^-$ , the alloy with a higher Ag content may be easily corroded and more corrosion products arise. Therefore, the difference of current density may be related to the variation of Ag content, i.e., a lower Ag content results in a lower anodic current peak (Fig. 5 and Table 2).

## 5 Conclusions

1) The relative length expansion and DIL maximum temperature  $T_{\text{lm}}$  (i.e., thermal stability) of  $\text{Au}_{52}\text{Cu}_{27}\text{Ag}_{17-x}(\text{NiZn}_{0.5})_x$  ( $x=0, 6$  and  $12$ ) alloys increase with



	Mole fraction/%		
	Au	Cu	Ag
Matrix	51.2	19.3	29.4
Particle	40.5	4.5	55.0



	Mole fraction/%				
	Au	Cu	Ag	Ni	Zn
Matrix	58.7	25.2	7.1	9.0	
Particle	46.3	11.4	28.3	11.0	2.9

**Fig. 8** SEM images and EDS results of  $\text{Au}_{52}\text{Cu}_{27}\text{Ag}_{17-x}(\text{NiZn}_{0.5})_x$  ((a)  $x=0$ , (b)  $x=12$ ) alloys after immersion in mixture solution of hydrochloric and nitric acid ( $V_{\text{HCl}}:V_{\text{HNO}_3}=1:1$ )

increasing  $x$ , which are ascribed to the weakening of the atomic binding energy and rise of the mismatch entropy together with phase transformation, respectively. The solid solution strengthening of Ni and Zn atoms due to their small atomic weight and radius is the main reason why the microhardness of the alloys increases and their lattice constant  $a_0$  decreases with increasing  $x$ .

2) The corrosion resistance of the alloy decreases with increasing  $x$  due to the increase of Ni-rich phase which has the lower corrosion potential than Au-rich phase. The appearance of anodic current peak is ascribed to the dissolution of alloy elements, such as Ag, Ni and Zn. In addition, the higher the  $x$ , the lower the anodic current peak, which is caused by the dissolution of Ag element in  $\text{Cl}^-$ -containing solution.

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## $\text{Au}_{52}\text{Cu}_{27}\text{Ag}_{17-x}(\text{NiZn}_{0.5})_x$ 合金的热膨胀行为、显微硬度和电化学耐腐蚀性能

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**摘要:** 利用热膨胀仪(DIL)、显微硬度计、电化学工作站、X 射线衍射仪(XRD)、扫描电子显微镜(SEM)、透射电子显微镜(TEM)、X 射线光电子能谱(XPS)研究了  $\text{Au}_{52}\text{Cu}_{27}\text{Ag}_{17-x}(\text{NiZn}_{0.5})_x$  ( $x=0, 6, 12$ )合金的热膨胀行为、显微硬度和电化学耐腐蚀性。随着  $x$  的增加, 在热膨胀实验测试中合金的相对长度膨胀量和 DIL 曲线极大值的温度  $T_{\text{lm}}$ (即热稳定性)增加, 这可以归因于原子结合能、错配熵的变化以及相变。增加  $x$ , 合金的显微硬度可以得到提高, 但是耐腐蚀性下降; 此外, 极化曲线的阳极电流峰密度随着  $x$  的增加而下降, 这些结果与固溶度以及 Ag、Ni、Zn 合金元素在含  $\text{Cl}^-$ 离子溶液中的溶解密切相关。

**关键词:** 金合金; 热膨胀; 显微硬度; 耐腐蚀性

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